

NoRHDIa Workshop 2008 09 -10 June 2008

RECENT PROGRESS IN THE FIELD OF DIAMOND HETEROEPITAXY ON IRIDIUM

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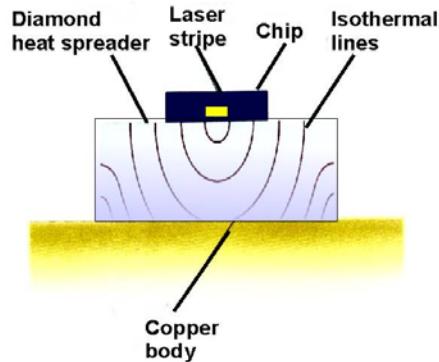
OUTLINE

- Motivation
- Heteroepitaxy of diamond: a brief review
- Bias enhanced nucleation (BEN)
- Diamond films on Iridium: state of the art
- Scaling-up: state of the art
- Understanding BEN on Iridium: A model summarizing the major observations



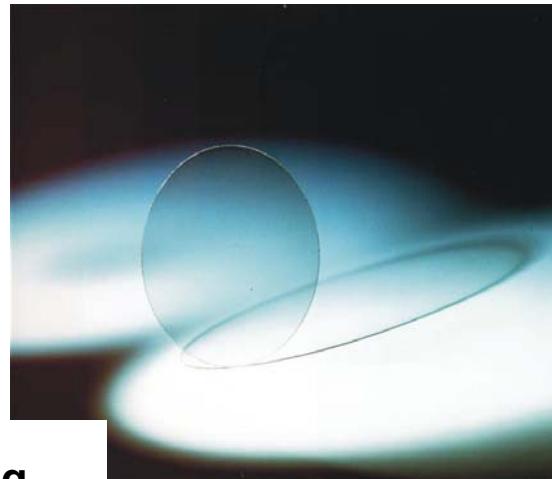
MOTIVATION

Heat spreaders



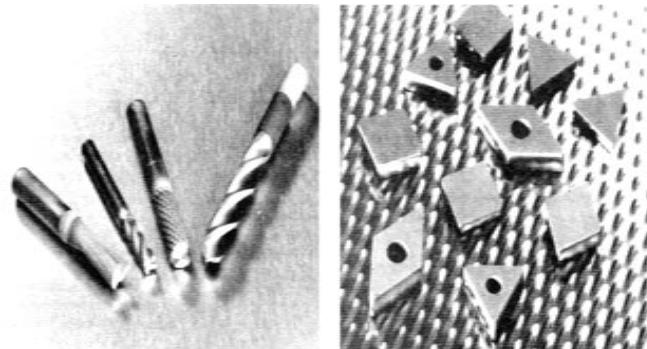
Source: E6

Windows for high power CO₂-lasers



Source: FHG-IAF Freiburg

Coatings on tools for drilling and milling (wear reduction)



Is there any need
for single crystals?

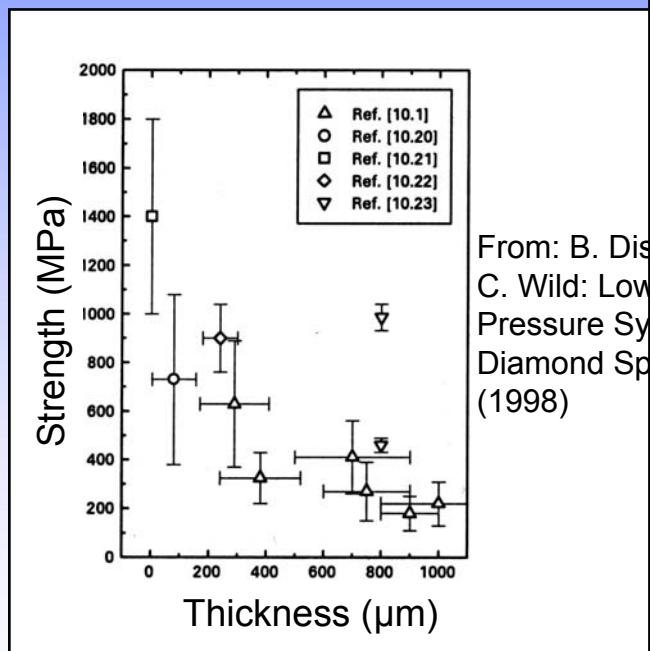
WHAT'S THE NEED FOR SINGLE CRYSTALS? (LIMITING PROPERTIES OF POLYCRYSTALLINE FILMS)

Mechanical properties

Strength:

Theoretical values: 120-190 GPa

Diamond single crystals (exp.): 2.8



From: B. Dis
C. Wild: Low
Pressure Sy
Diamond Sp
(1998)

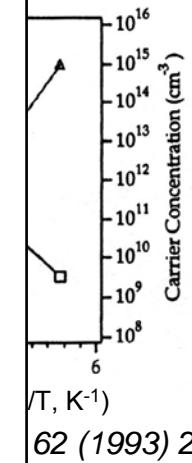
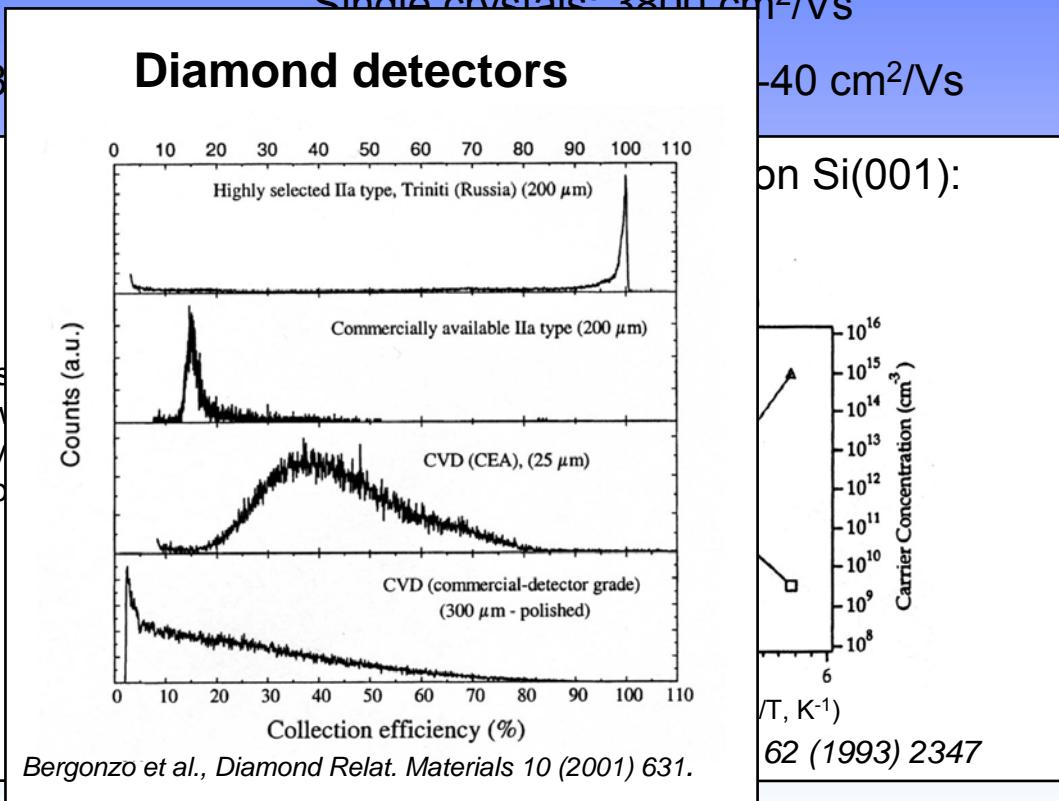
Electrical properties

Charge carrier mobilities (holes):

Single crystals: $3800 \text{ cm}^2/\text{Vs}$

- $40 \text{ cm}^2/\text{Vs}$

on Si(001):



62 (1993) 2347



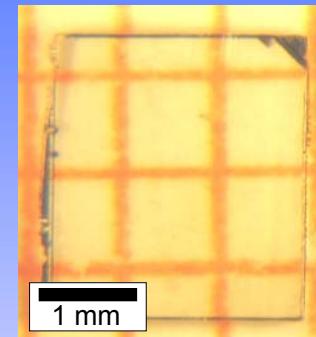
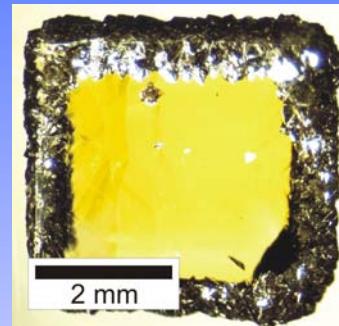
HOMOEPIТАХY



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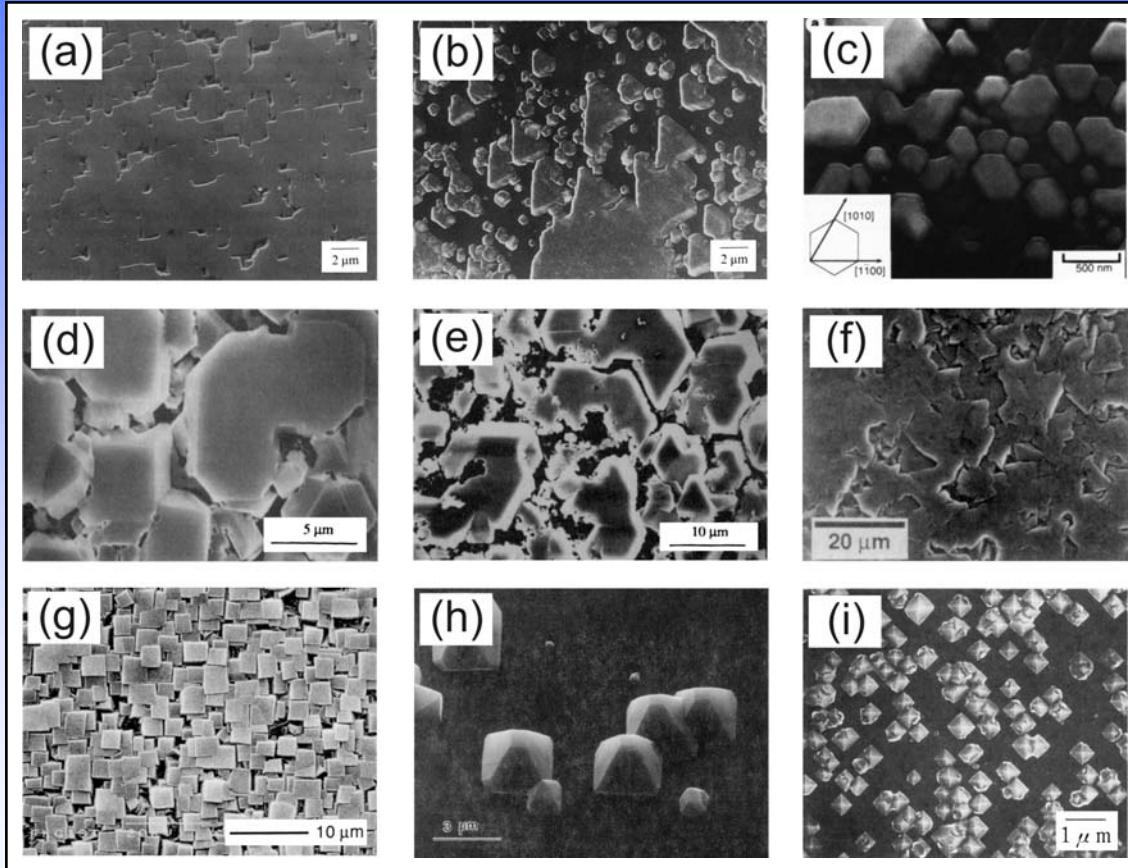


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WIRED (Sept. 2003)
Linares (Apollo).... the company is producing 10-millimeter wafers but predicts it will reach an inch square by year's end and 4 inches in five years.

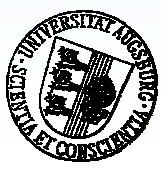
HETEROEPITAXY OF DIAMOND: SEARCHING FOR THE IDEAL SUBSTRATE MATERIAL



- (a) c-BN(001)
- (b) c-BN(111)
- (c) $\text{Al}_2\text{O}_3(0001)$
- (d) Ni(001)
- (e) Ni(111)
- (f) Pt(111)
- (g) Si(001)
- (h) $\beta\text{-SiC}(001)$
- (i) Ir/MgO(001)

HETEROEPITAXY OF DIAMOND: SEARCHING FOR THE IDEAL SUBSTRATE MATERIAL

Substrate	First Publication	Current state of the art
Diamond on β -SiC:	Stoner & Glass 1992	Tilt: 0.6° Twist: $\sim 2.5^\circ$
Diamond on silicon:	Jiang & Klages 1992	Tilt: $\sim 1^\circ$ Twist: $\sim 4^\circ$
Diamond on Pt:	Tachibana, Kobashi, Shintani 1996	Tilt: 1.1° Twist: -
Diamond on Ir:	Ohtsuka, Suzuki, Sawabe, Inuzuka 1996	Tilt: 0.16° Twist: 0.34°
Further materials: c-BN, Cu, Ni, Co, Re, TiC, Ni_3Si , Ni_3Ge , Al_2O_3		



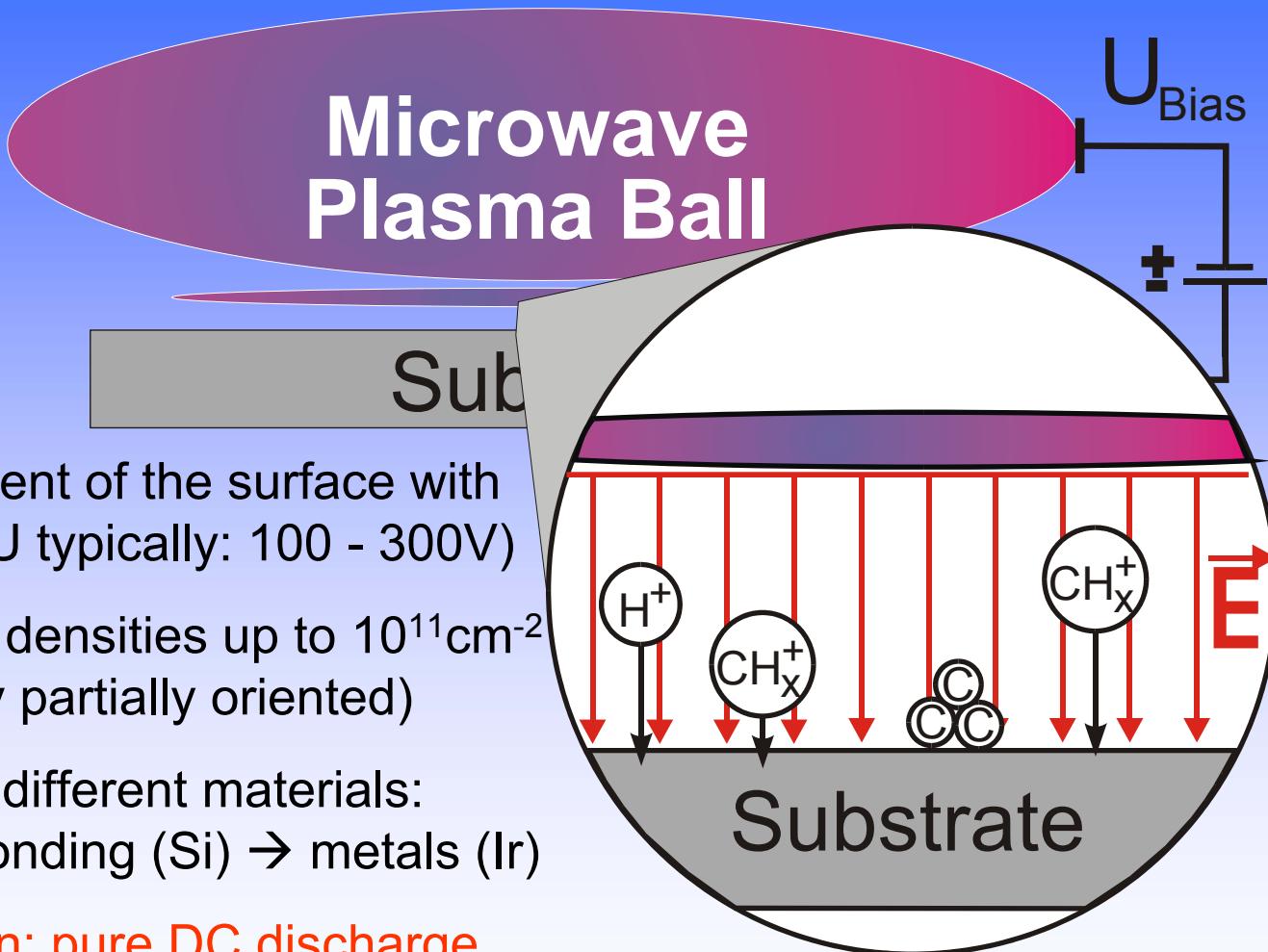
BIAS ENHANCED NUCLEATION (BEN)

Microwave
plasma ball

Substrate



BIAS ENHANCED NUCLEATION (BEN)



Bombardment of the surface with pos. ions (U typically: 100 - 300V)

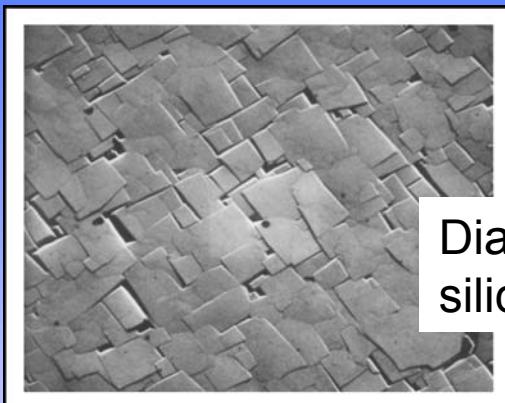
Nucleation densities up to 10^{11} cm^{-2}
(on Si, only partially oriented)

Epitaxy on different materials:
covalent bonding (Si) \rightarrow metals (Ir)

Modification: pure DC discharge

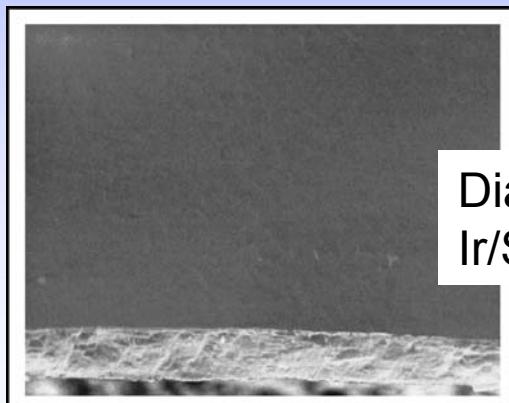
COMPARISON: DIAMOND ON Si ⇌ DIAMOND ON Ir/SrTiO₃

The film surface

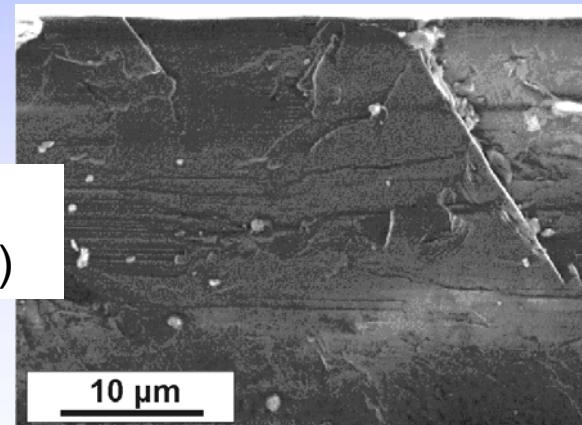


Diamond on
silicon

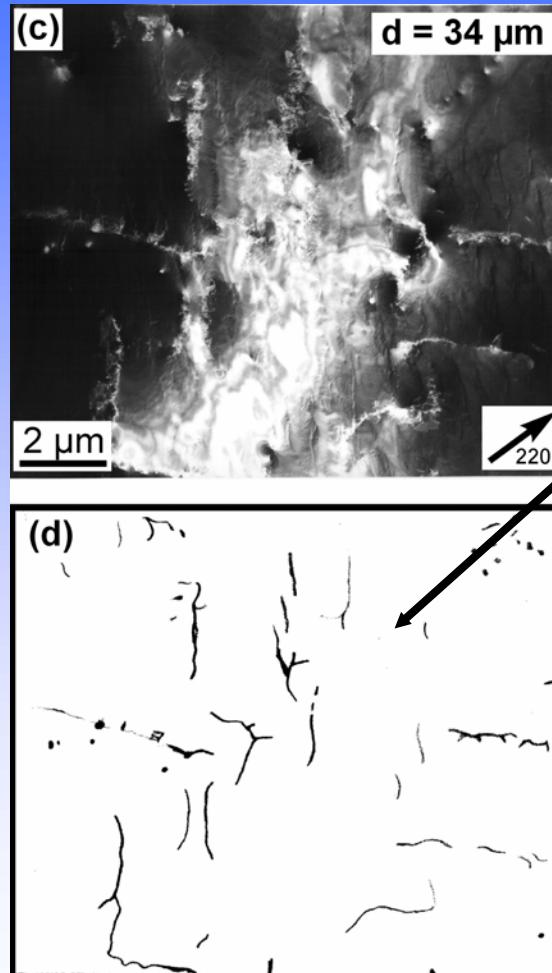
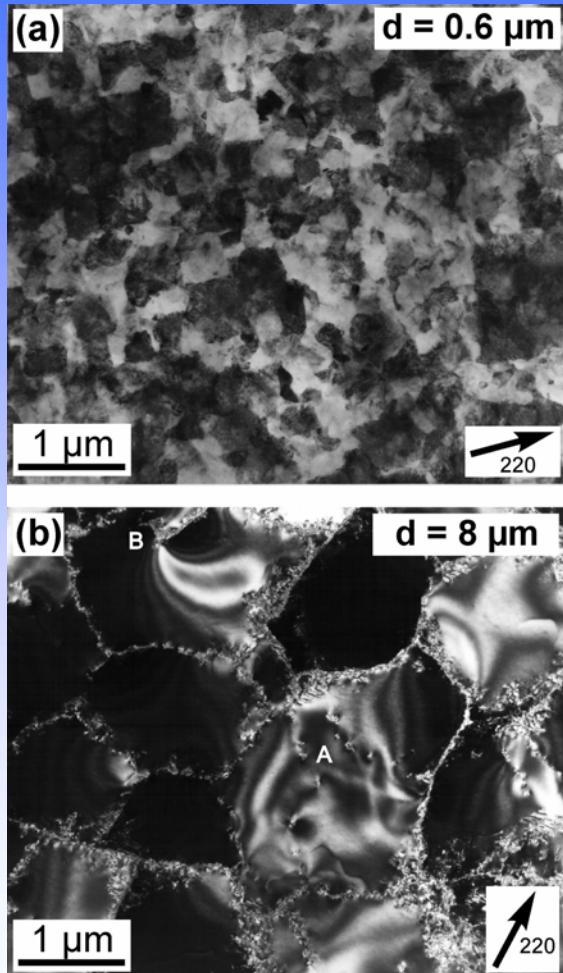
The cross section



Diamond on
Ir/SrTiO₃(001)



INTERNAL DEFECT STRUCTURE: TRANSMISSION ELECTRON MICROSCOPY (TEM)



Schematic sketch of
defect bands from TEM
image in (c)

During textured growth:
**closed network of grain
boundaries**



**isolated short defect bands
(quasi single crystal)**



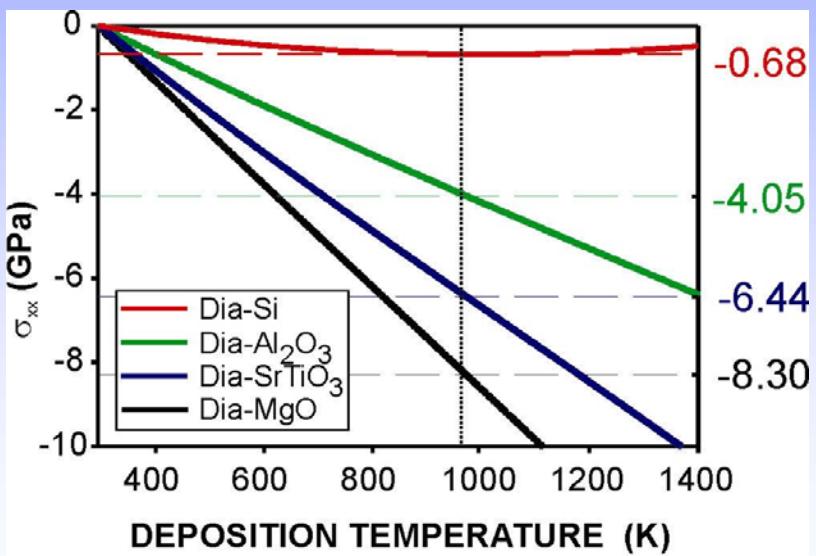
The technological challenge: finding an appropriate multilayer system



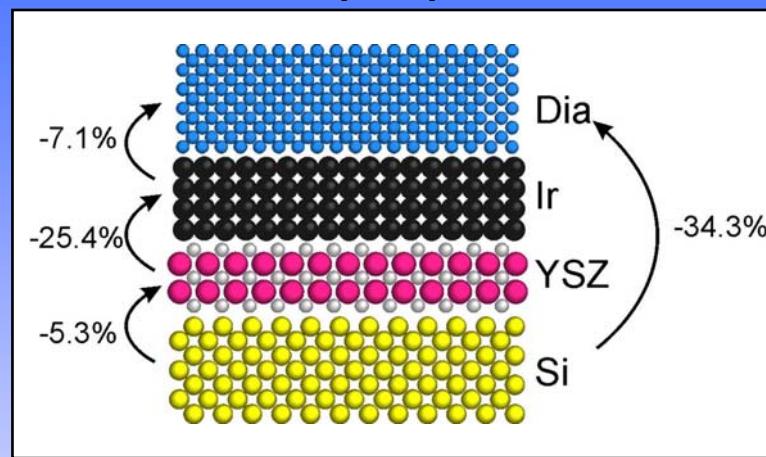
OXIDE SINGLE CRYSTALS vs. BUFFER LAYERS ON SILICON

Requirements:

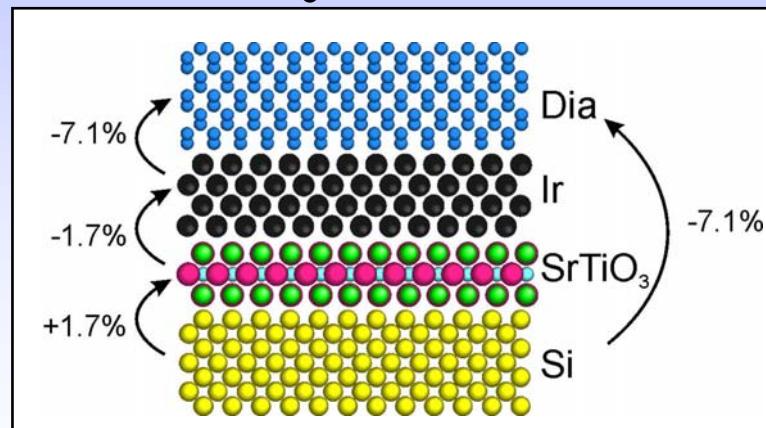
- Growth of single crystal iridium films
- Thermally compatible with diamond



Dia/Ir/YSZ/Si(001)



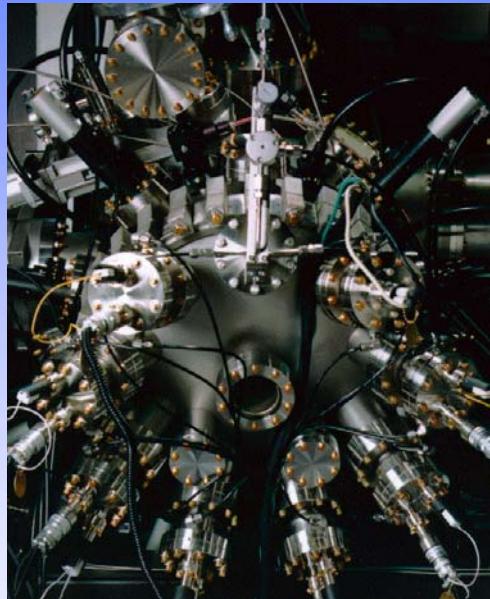
Dia/Ir/SrTiO₃/Si(001)



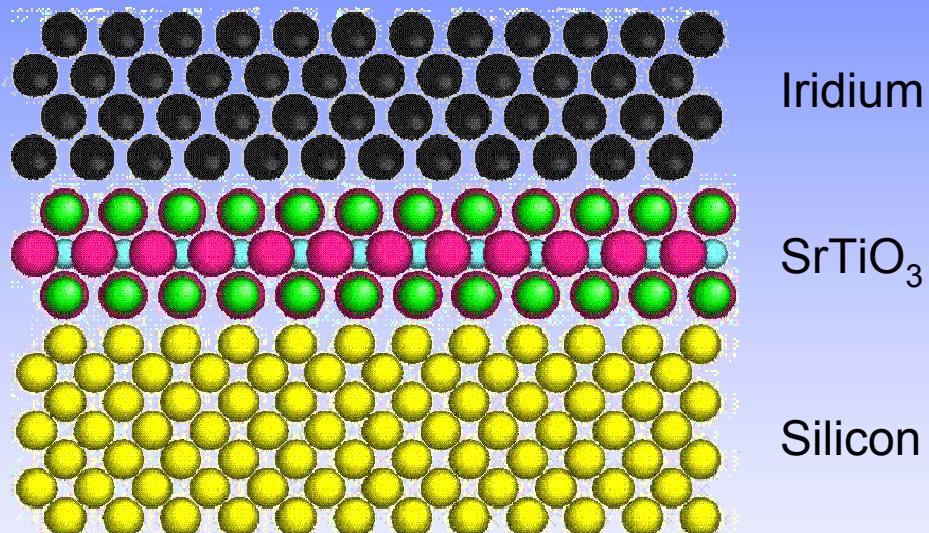
IRIDIUM ON SILICON VIA SrTiO₃ BUFFER LAYERS

Epitaxial iridium directly on silicon not possible

→ Oxide buffer layers between silicon and iridium



MBE-System (Prof. D. Schlom,
Pennsylvania State University)



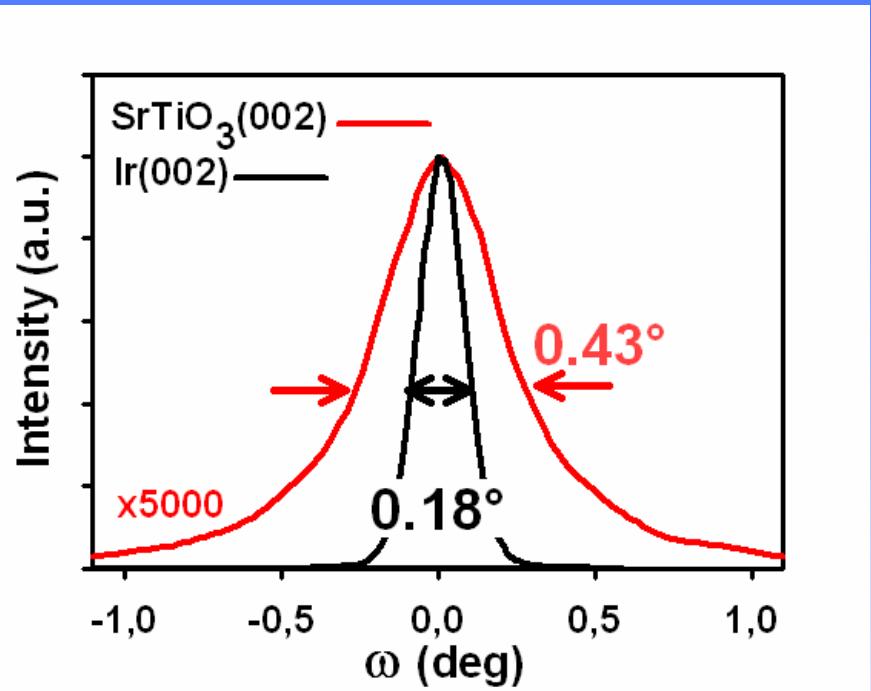
SrTiO₃ buffer layer by MBE growth (mosaicity: tilt/twist: 0.43°/1.36°)

For details: L.V. Goncharova et al., J. Appl. Phys. 100, 014912 (2006)

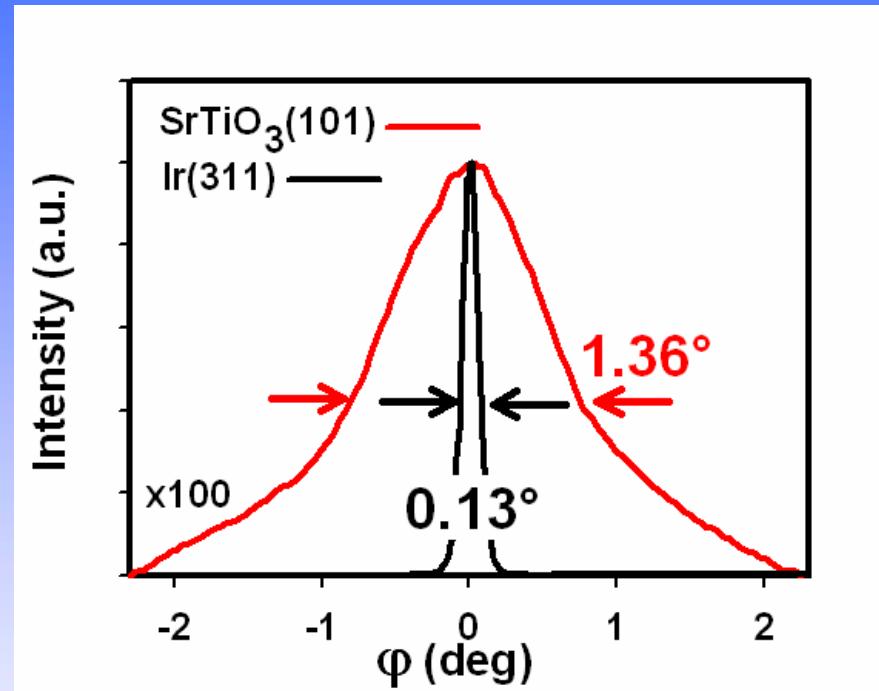


MOSAIC SPREAD OF THE IR FILMS

Rocking curve



Azimuthal scan



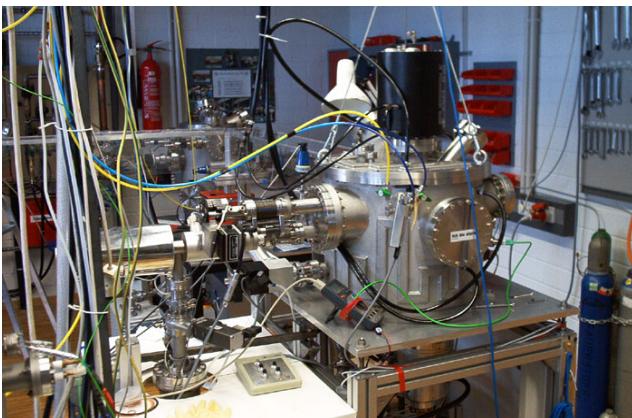
→ Mosaicity (angular spread) of the iridium much lower than that of the underlying oxide buffer layer

Gsell *et al.*, *Appl. Phys. Lett.*, **91**, 061501(2007).

2. THE ALTERNATIVE CONCEPT: YSZ ON Si PREPARED BY PLD

Pulsed laser deposition (PLD) setup

Laser pulse



KrF excimer laser

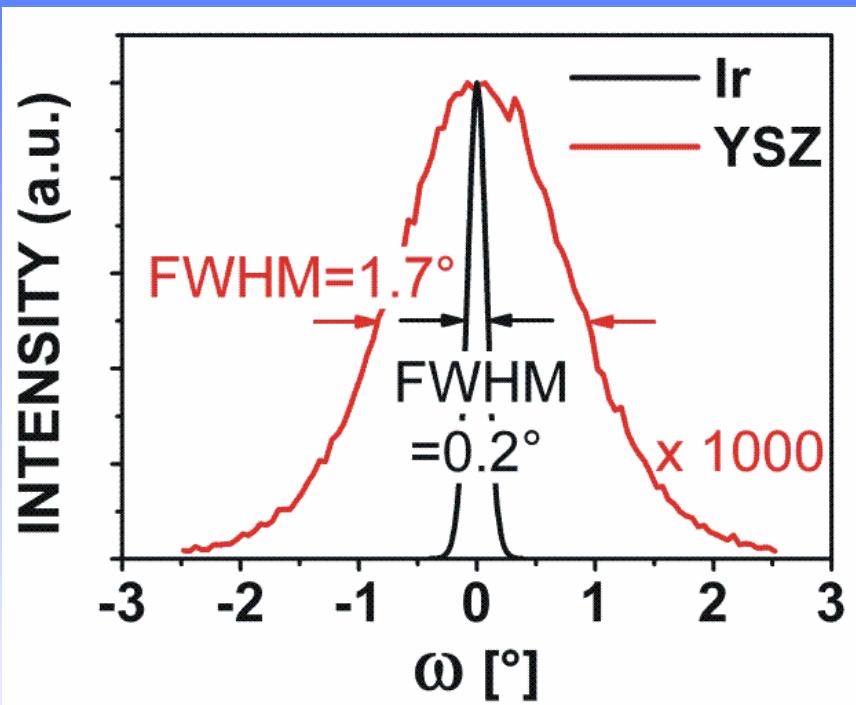
25 ns pulses of 850 mJ

Yttria stabilized zirconia (YSZ) film deposition:

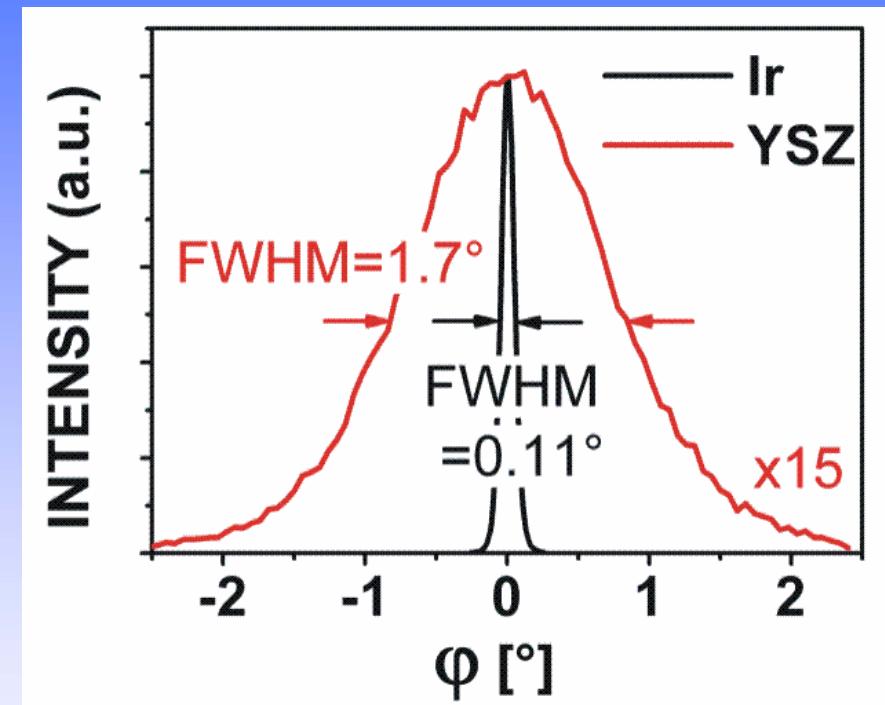
- no removal of the silicon oxide
- ablation target: (ZrO_2) stabilized with Y_2O_3
- 5×10^{-2} Pa oxygen (First 600 pulses without oxygen)
- substrate temperature: 825°C
- thickness: 20 nm (40 nm)

HETEROEPITAXIAL IRIDIUM ON YSZ/Si(001)

Rocking curve

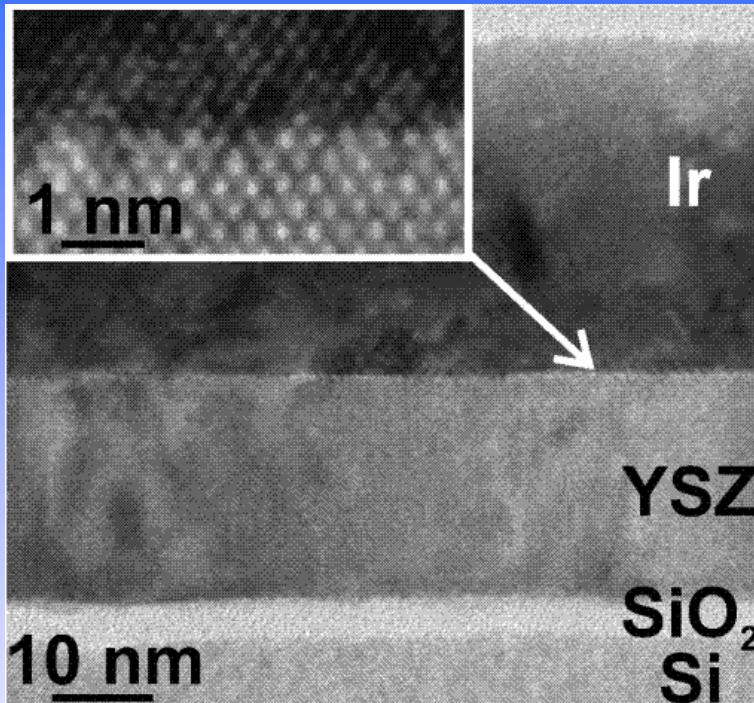


Azimuthal scan



Order of magnitude lower mosaic spread for the iridium film than for the YSZ

MICROSTRUCTURE AND INTERFACE



Cross section TEM micrograph

Dislocation density of iridium: $\sim 10^{11} \text{ cm}^{-2}$

Crystalline interface Ir/YSZ

Dislocation density of YSZ: $\sim 10^{12} \text{ cm}^{-2}$

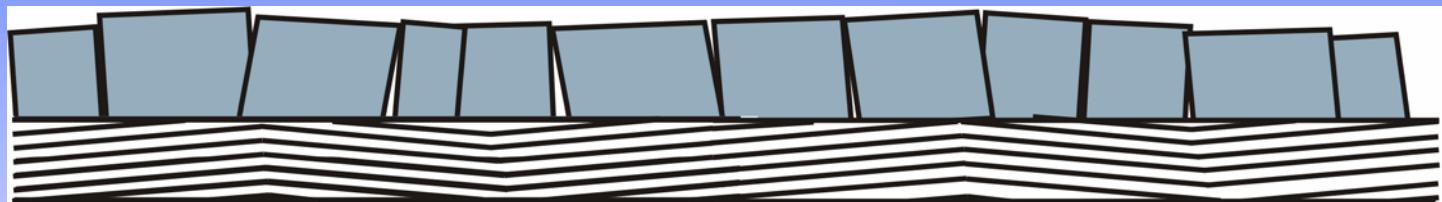
Crystalline quality of the iridium is significantly higher than that of the YSZ directly from the interface

→ Mechanism?

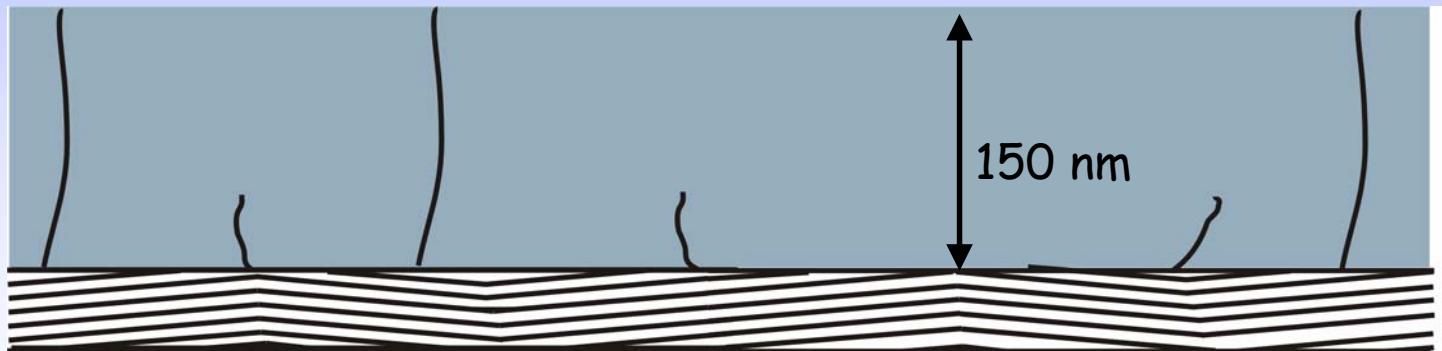
MECHANISM OF TEXTURE IMPROVEMENT DURING IRIDIUM DEPOSITION



Iridium islands on misoriented oxide



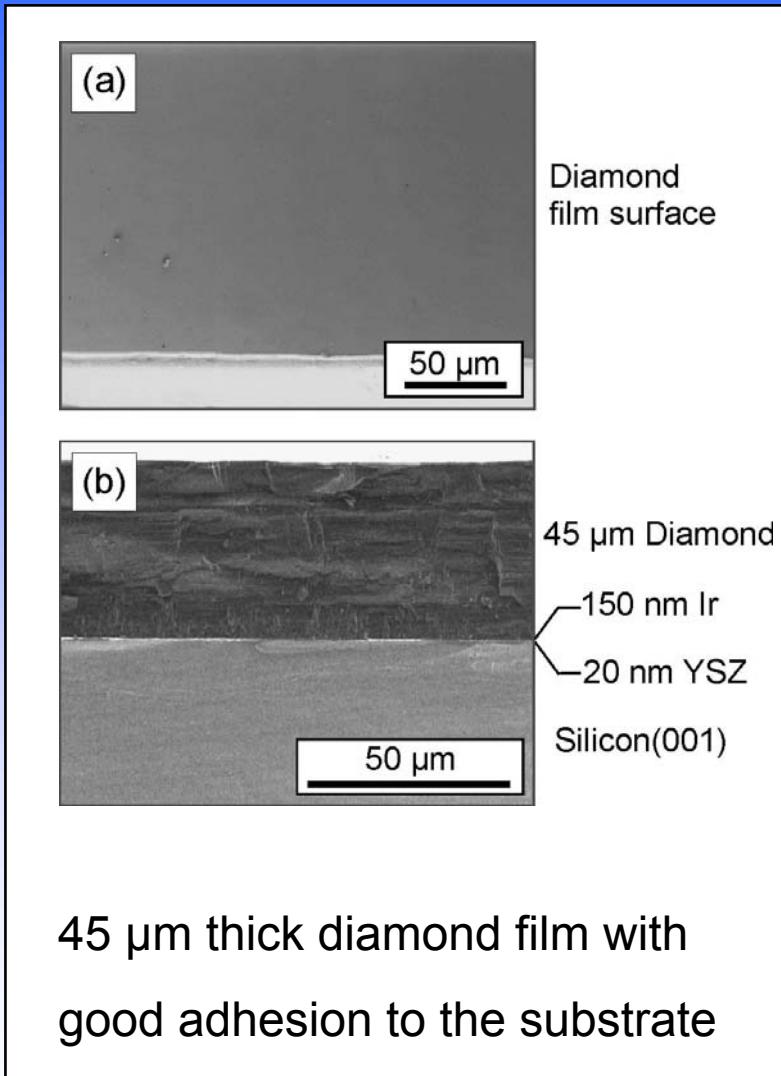
Mechanism I: averaging process during the coalescence of the iridium islands



Mechanism II: burying of defects



THICK DIAMOND FILMS ON Ir/YSZ/Si(001)

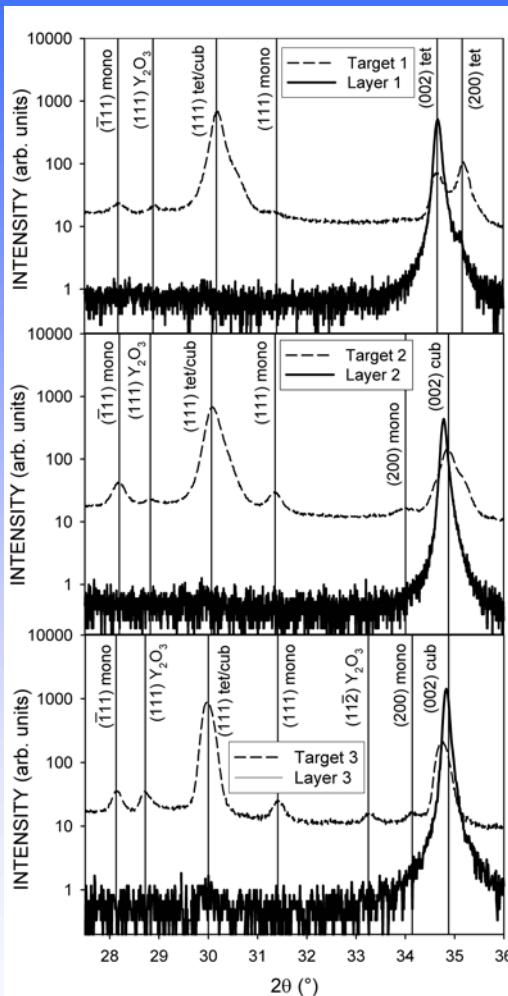


WHAT IS THE BEST STOICHIOMETRY FOR YSZ BUFFER LAYERS?

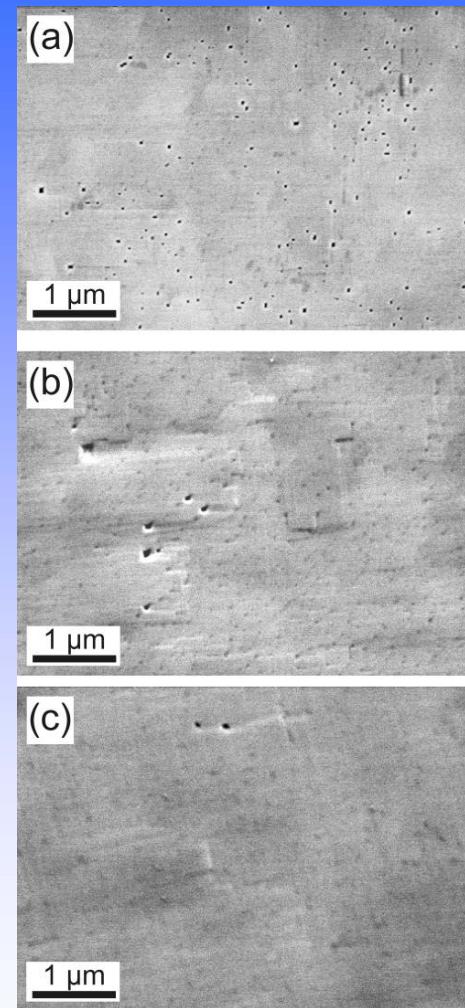
2 (of 3) different ablation targets



Laser plume
During ablation



Tetragonal => cubic YSZ

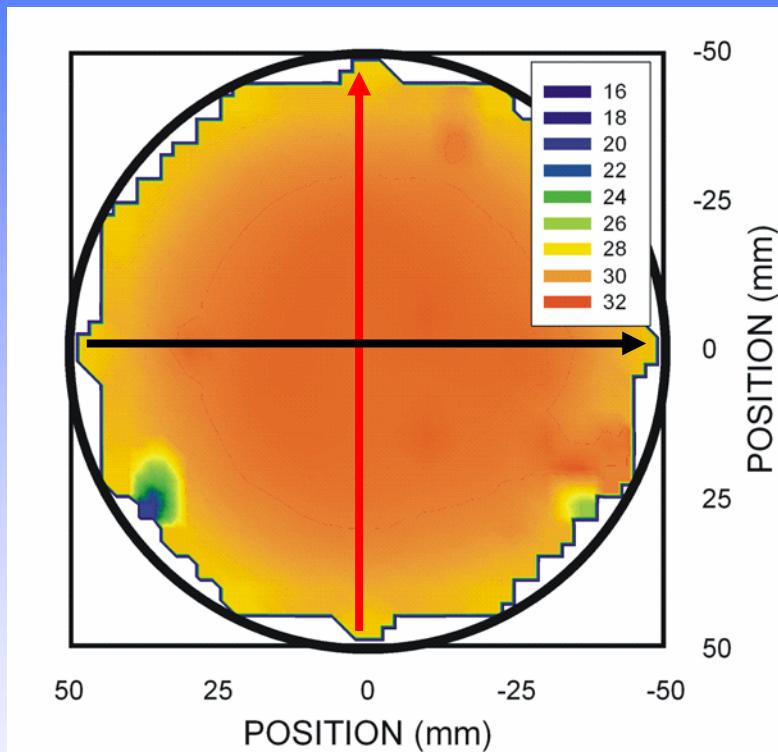


SEM
images
of Ir
surfaces

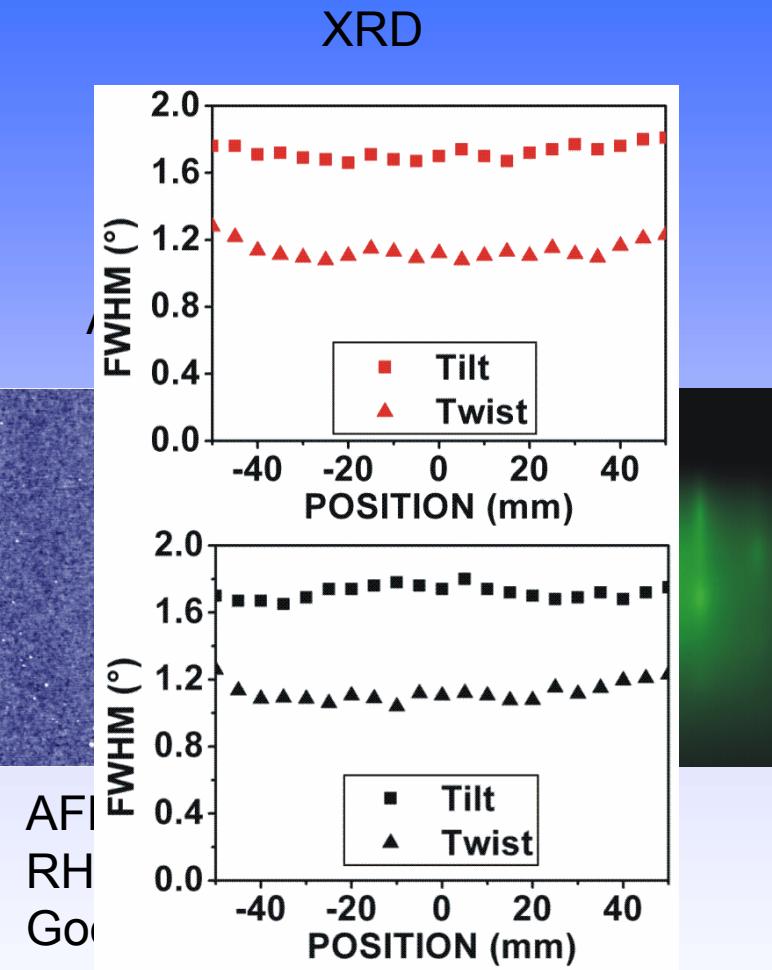


SCALING-UP TO 4": YSZ

YSZ:
grown by PLD on 4-inch silicon (001) wafers

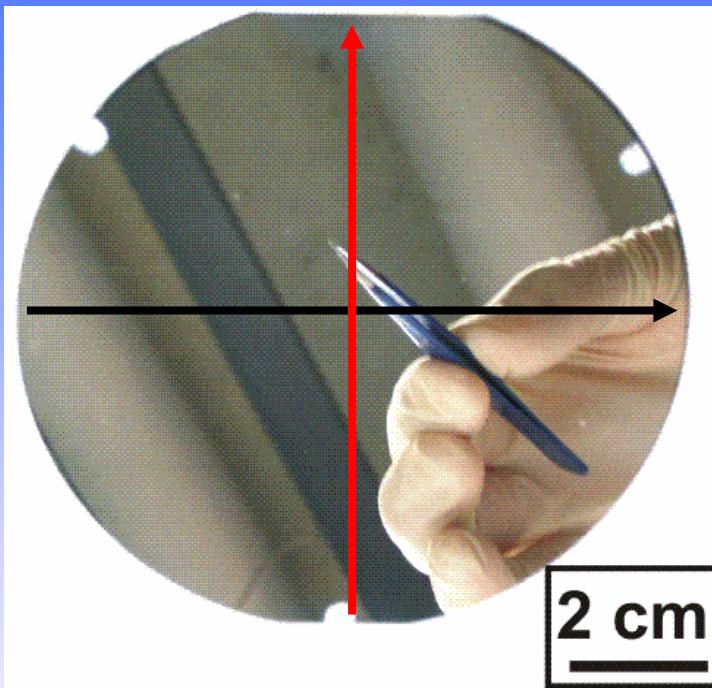


Homogeneous thickness (10% variation)
measured by ellipsometry

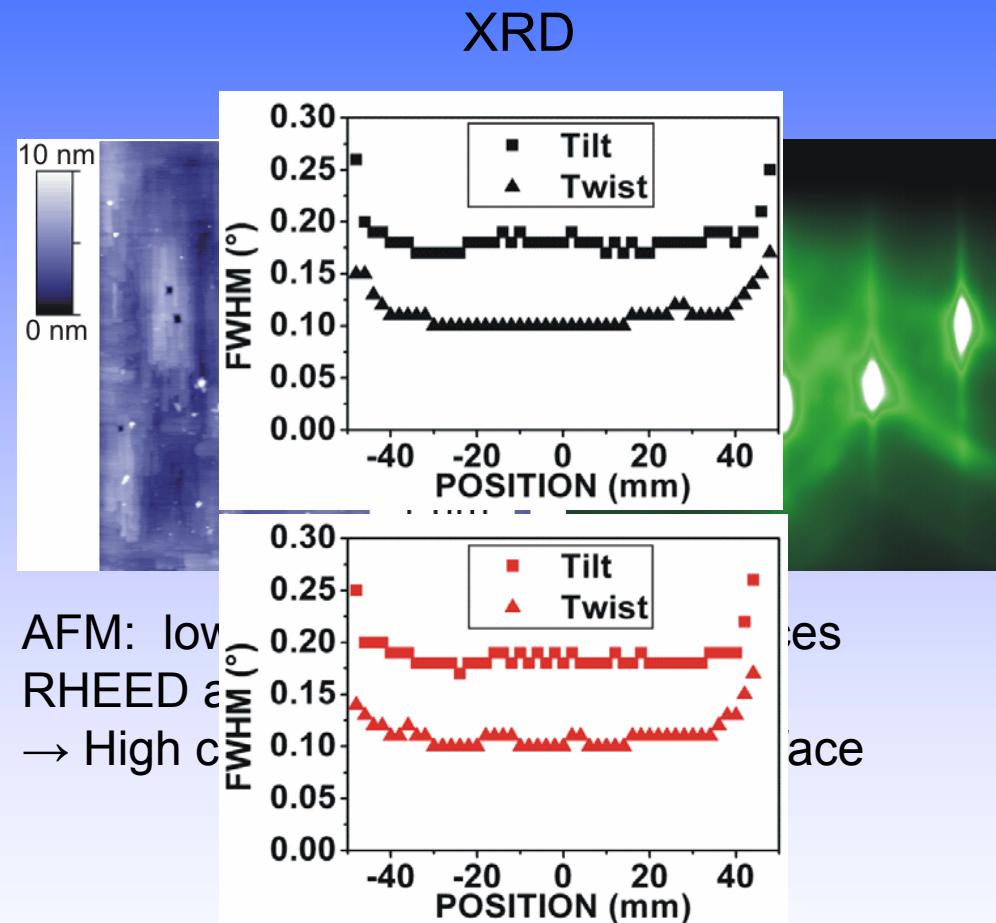


IRIDIUM WAFERS

Preparation of the iridium layer by e-beam evaporation on 4-inch YSZ/Si(001) wafers

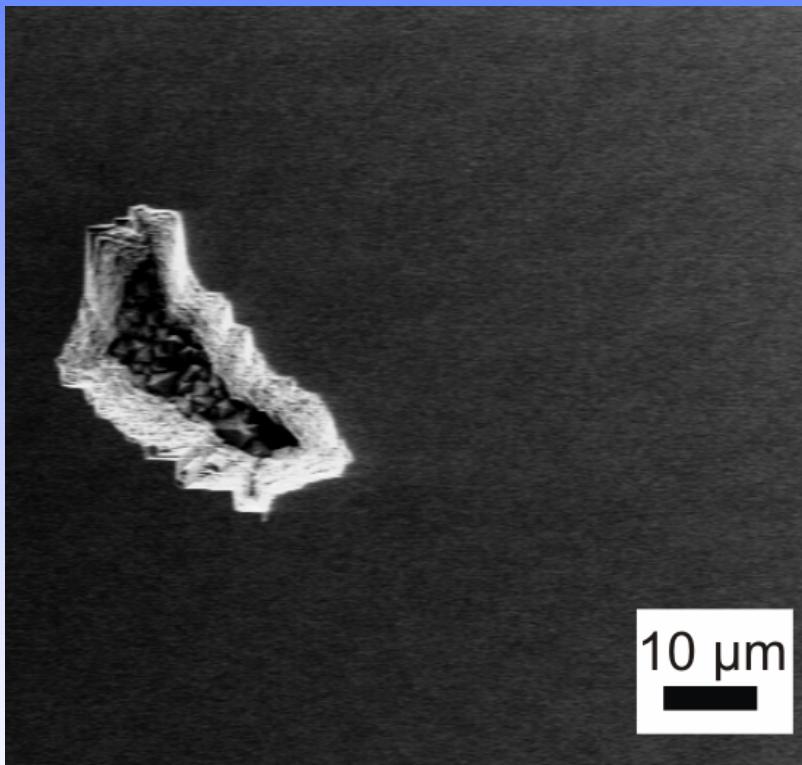


Mirror-like surface, thickness
between 135-150nm (RBS)



GROWTH OF DIAMOND ON 4" Ir/YSZ/Si(001) WAFERS

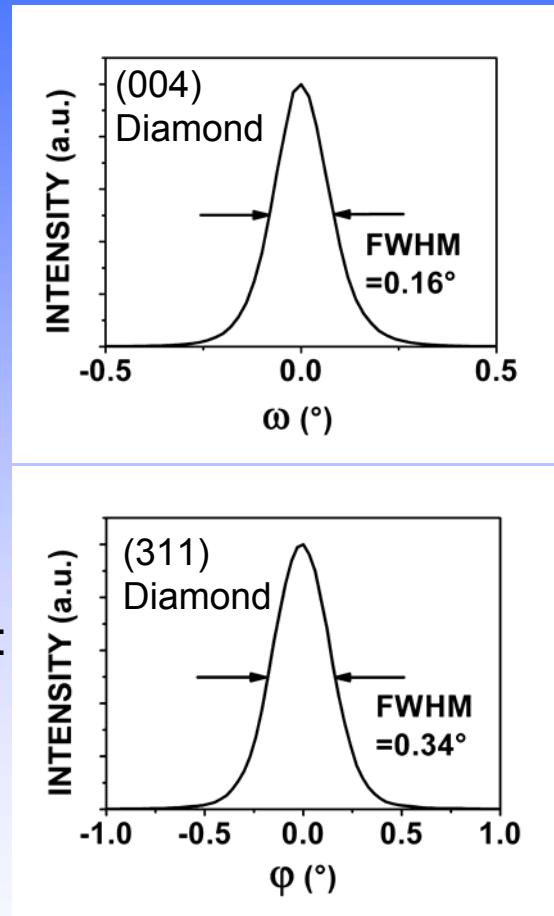
SEM



Thickness: 40 μm

XRD

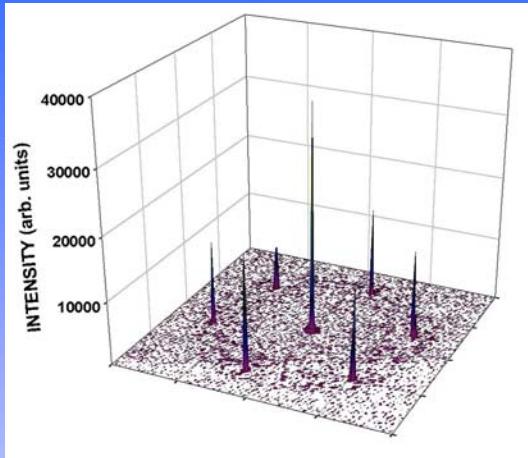
Rocking curve:



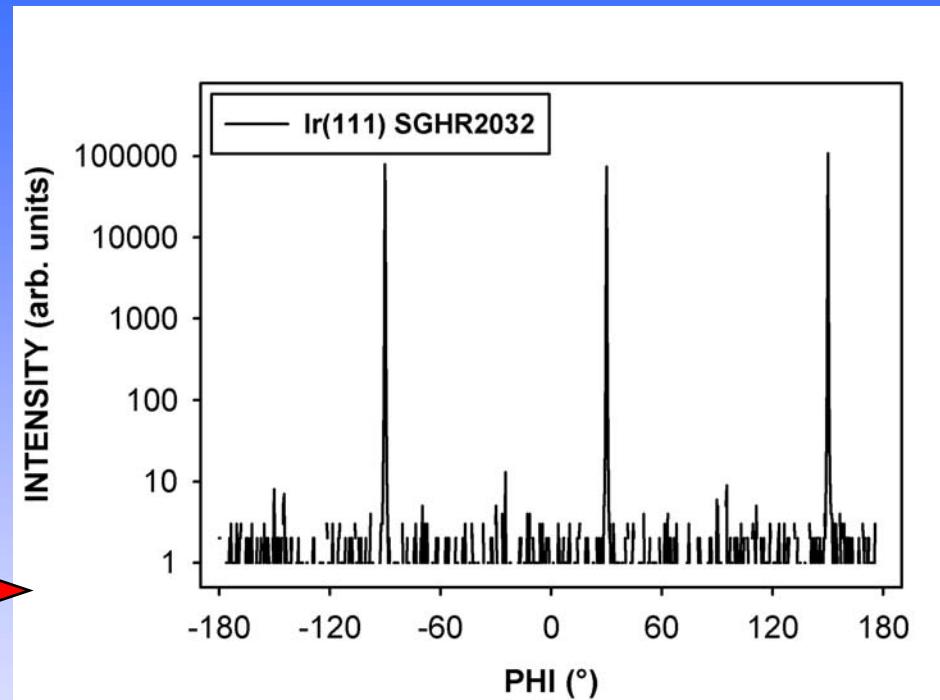
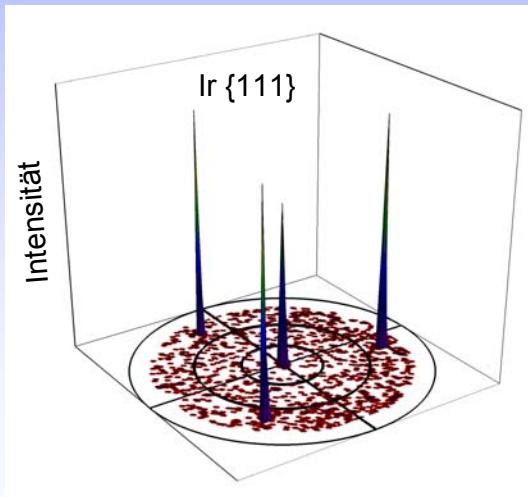
lowest values reported up to now

IR(111): EXTREMELY LOW TWINNING RATIO

Ir(111)/Al₂O₃(0001)



Ir(111)/YSZ(111)/Si(111)



Twinning < 10⁻⁴

Only one texture component

→ Monocrystalline metal films possible

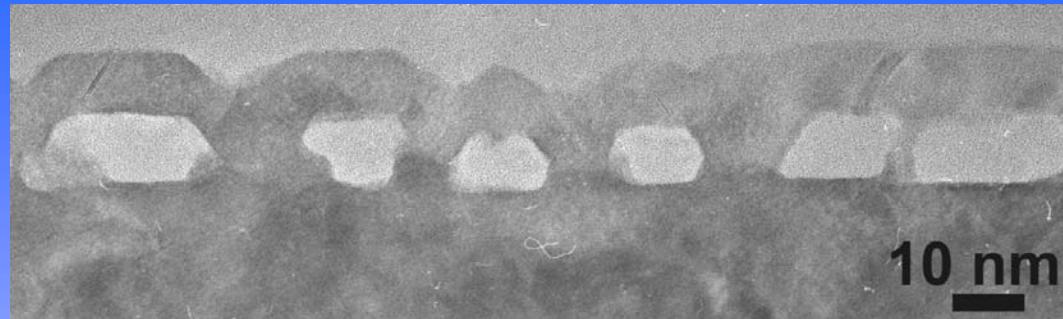
Why is Ir so much better than any other substrate?

=> Understanding BEN on Ir



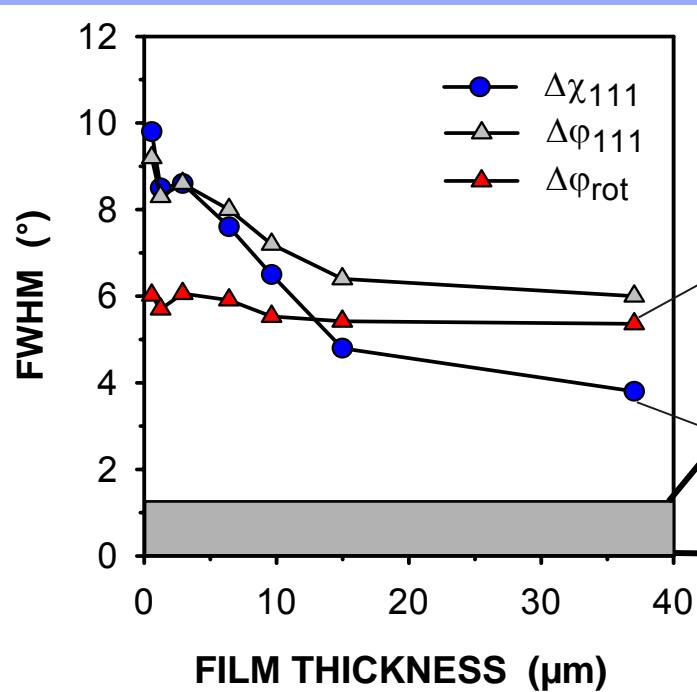
SPECIAL FEATURES OF DIAMOND ON IRIDIUM

Highest density of oriented grains

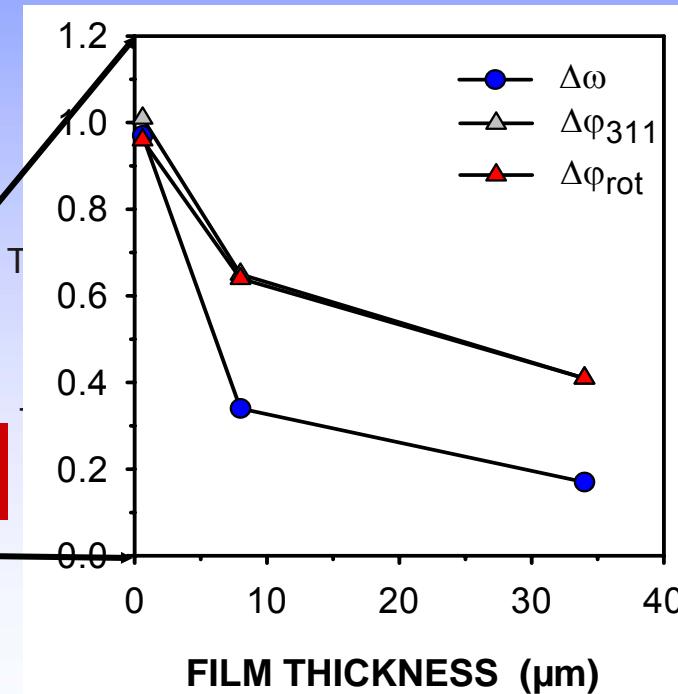


Cross section
TEM image
after 2 min
growth

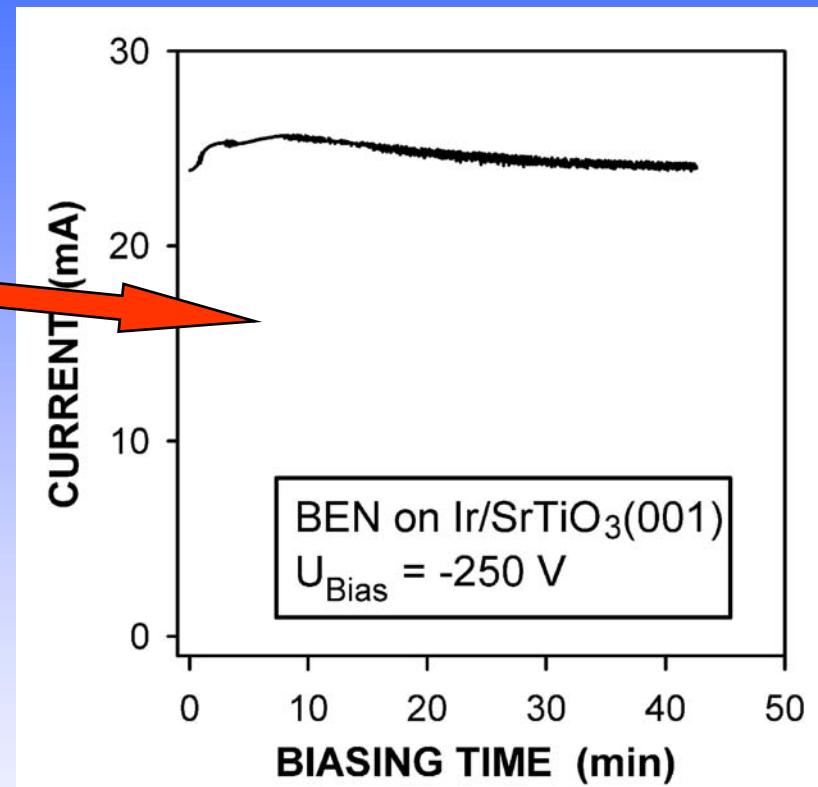
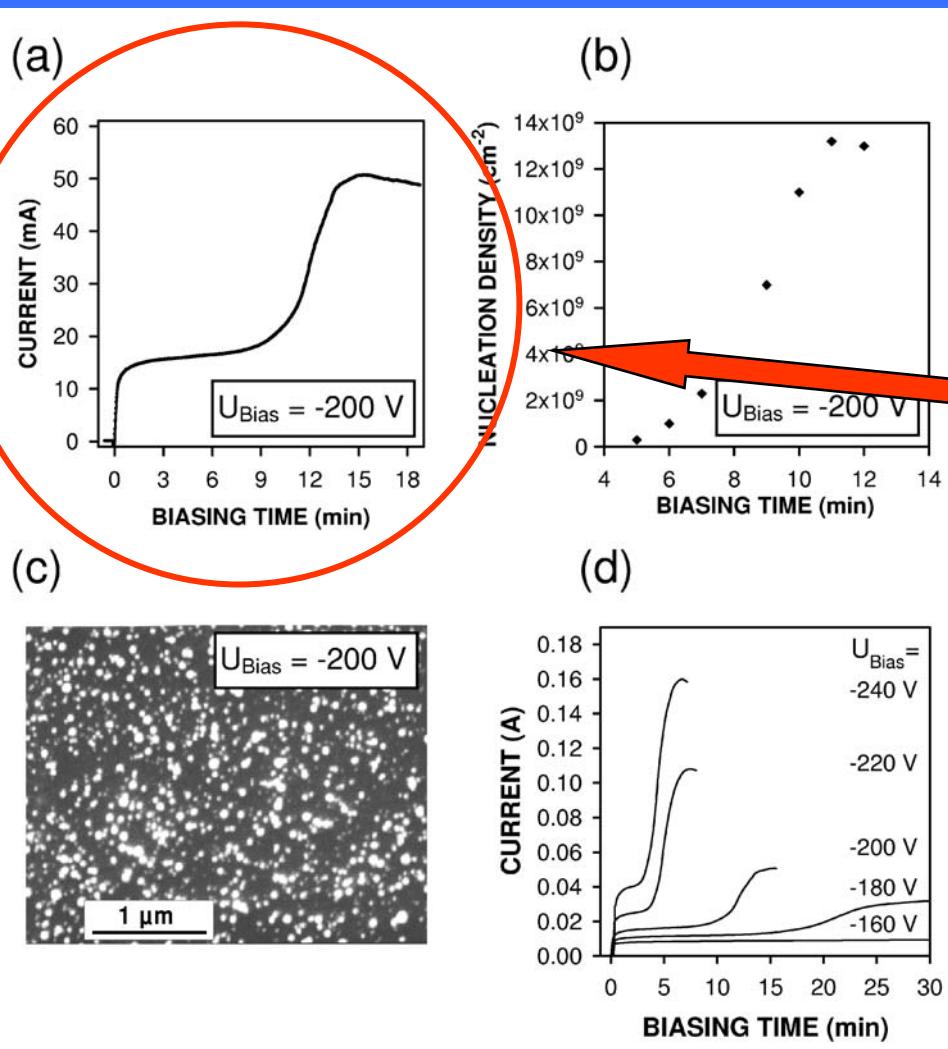
Dia/Si(001)



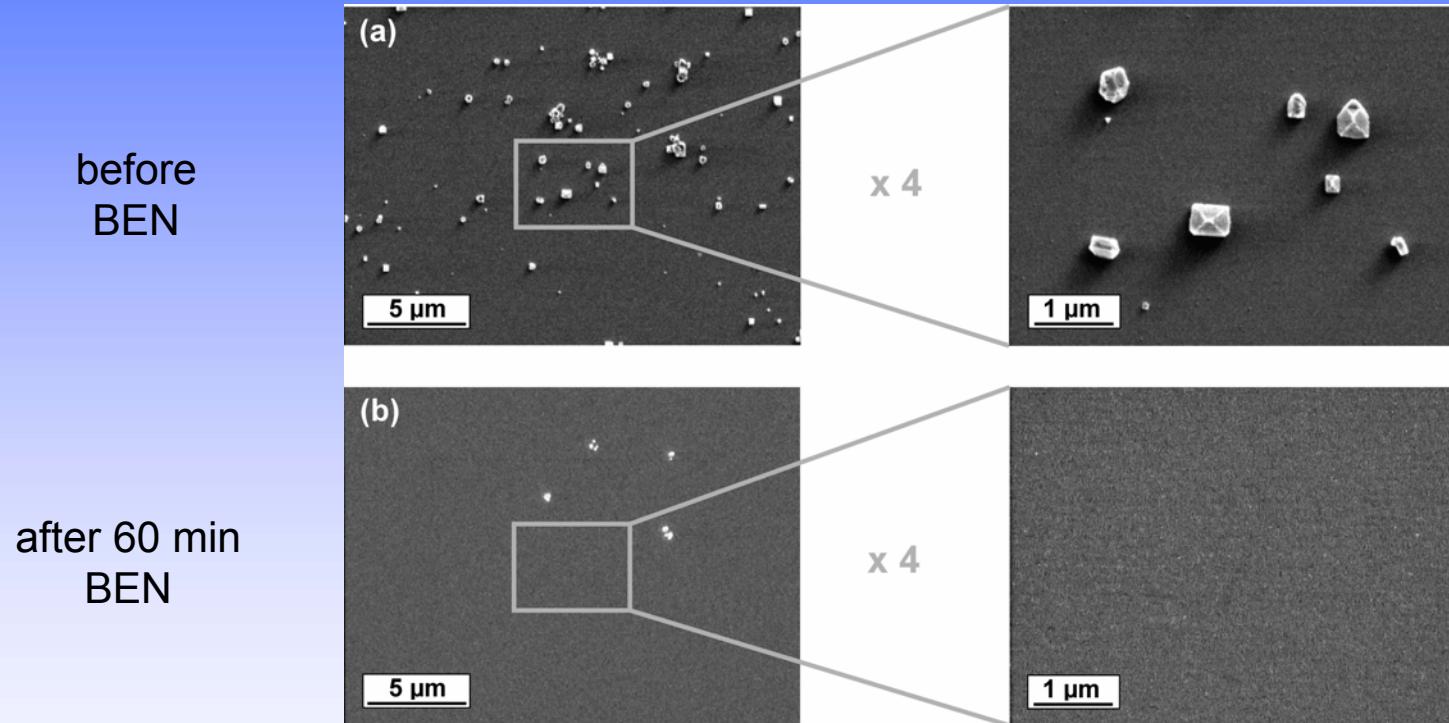
Dia/Ir/SrTiO₃(001)



NUCLEATION ON SILICON vs. IRIDIUM

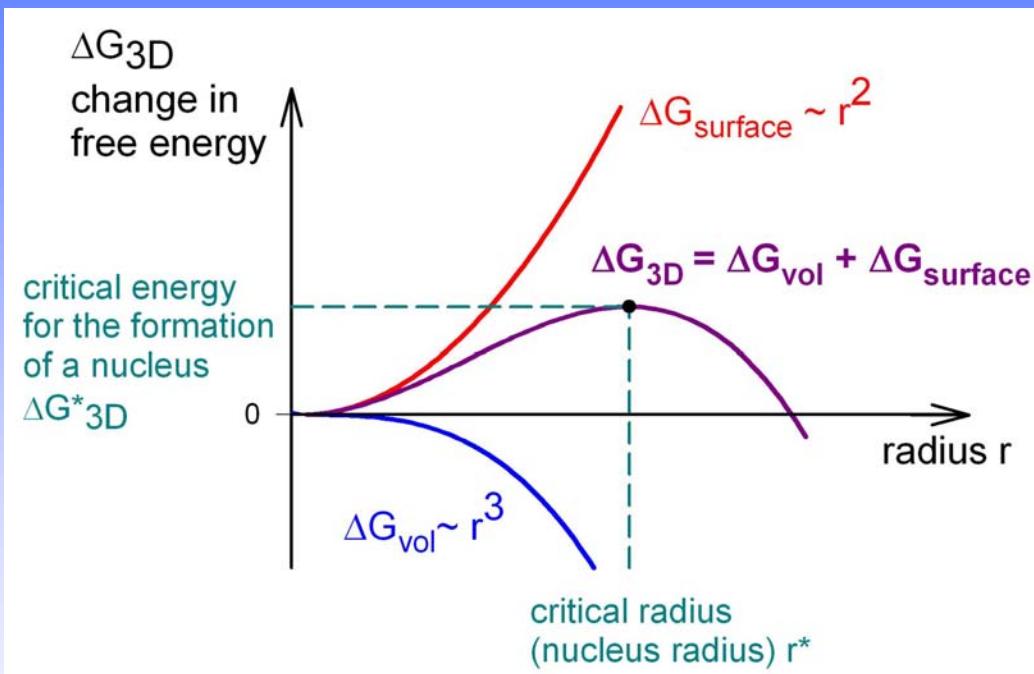


THE FATE OF DIAMOND GRAINS UNDER THE BIAS ENHANCED NUCLEATION CONDITIONS ON IRIDIUM



Diamond nucleation occurs under conditions under which diamond grains are etched!!!

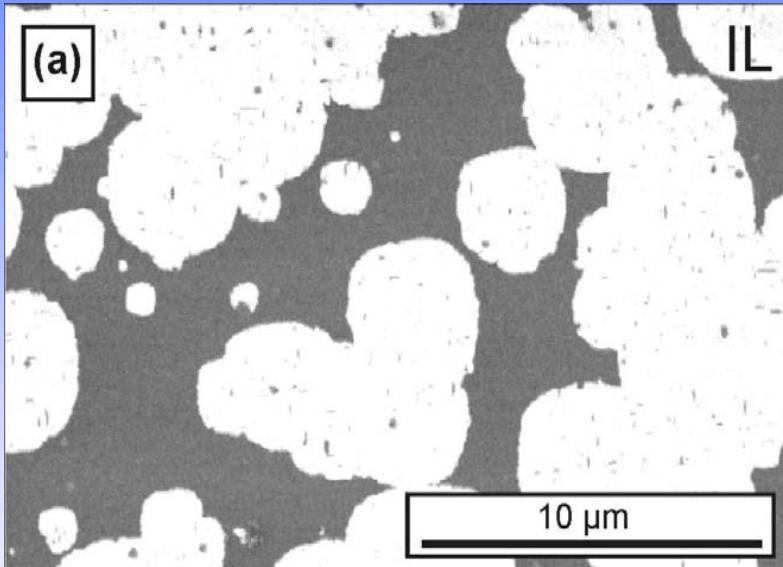
CLASSICAL NUCLEATION THEORY



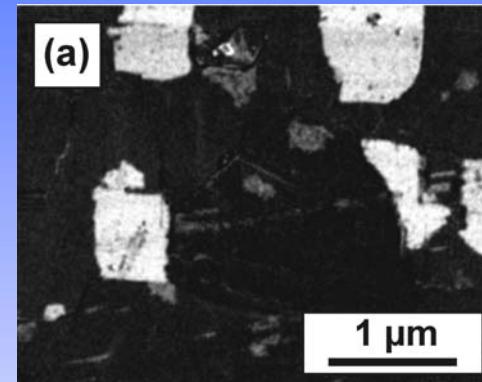
Nucleation under etching conditions contradicts classical nucleation theory

THE IRIDIUM SURFACE AFTER BEN

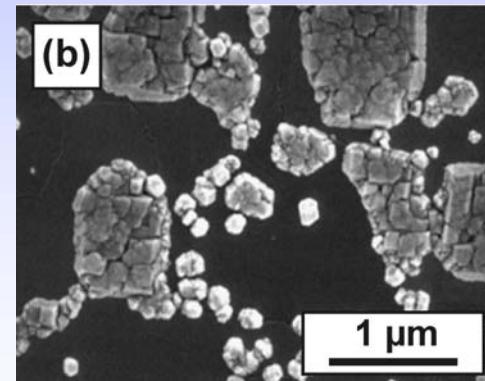
Bright domains in the SEM



Correspondence
Domains \longleftrightarrow Diamond islands??



Growth step 1 year later

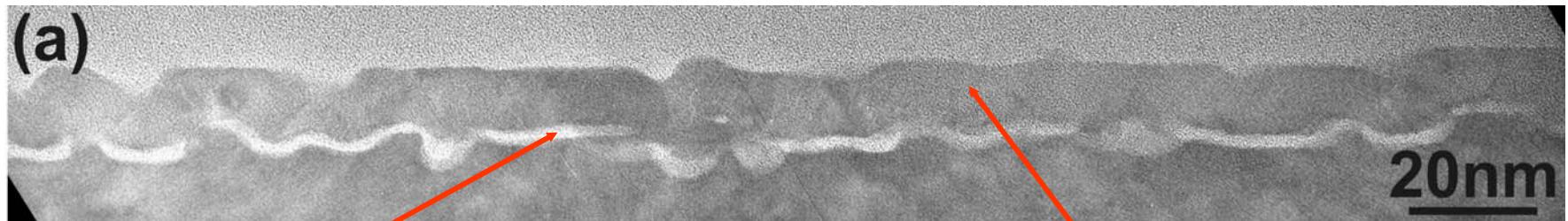


What is the amount of
carbon at the Ir surface
after BEN?

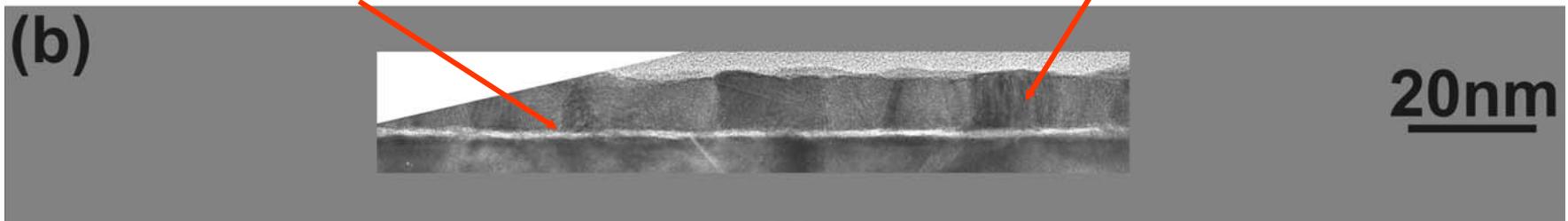


CROSS SECTION TEM IMAGES OF BEN SAMPLE 1 & 2

Rough sample



BEN layer flat sample Iridium covering layer

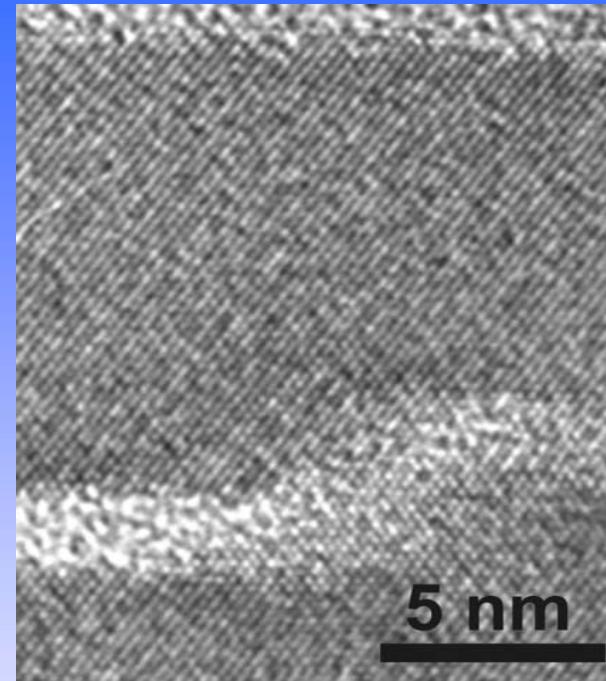
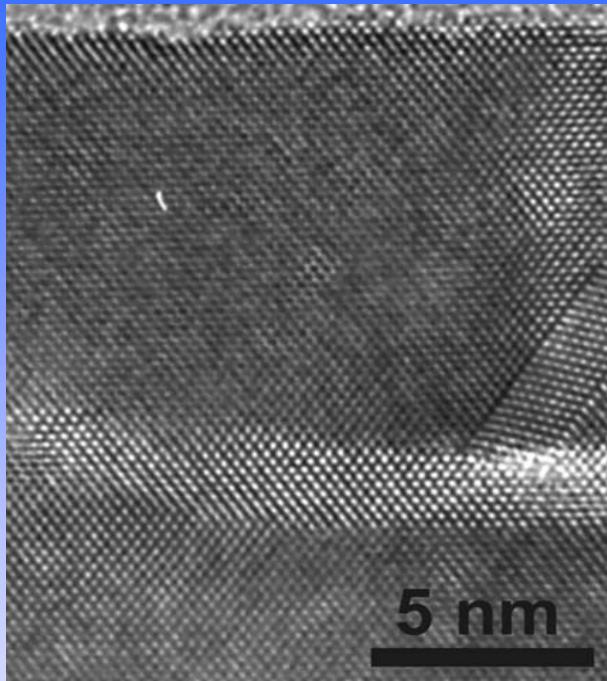


- A slit is clearly visible
- On the flat sample: continuous with rather homogeneous thickness
- Thickness: ~ 1 nm

The internal structure of the BEN layer?

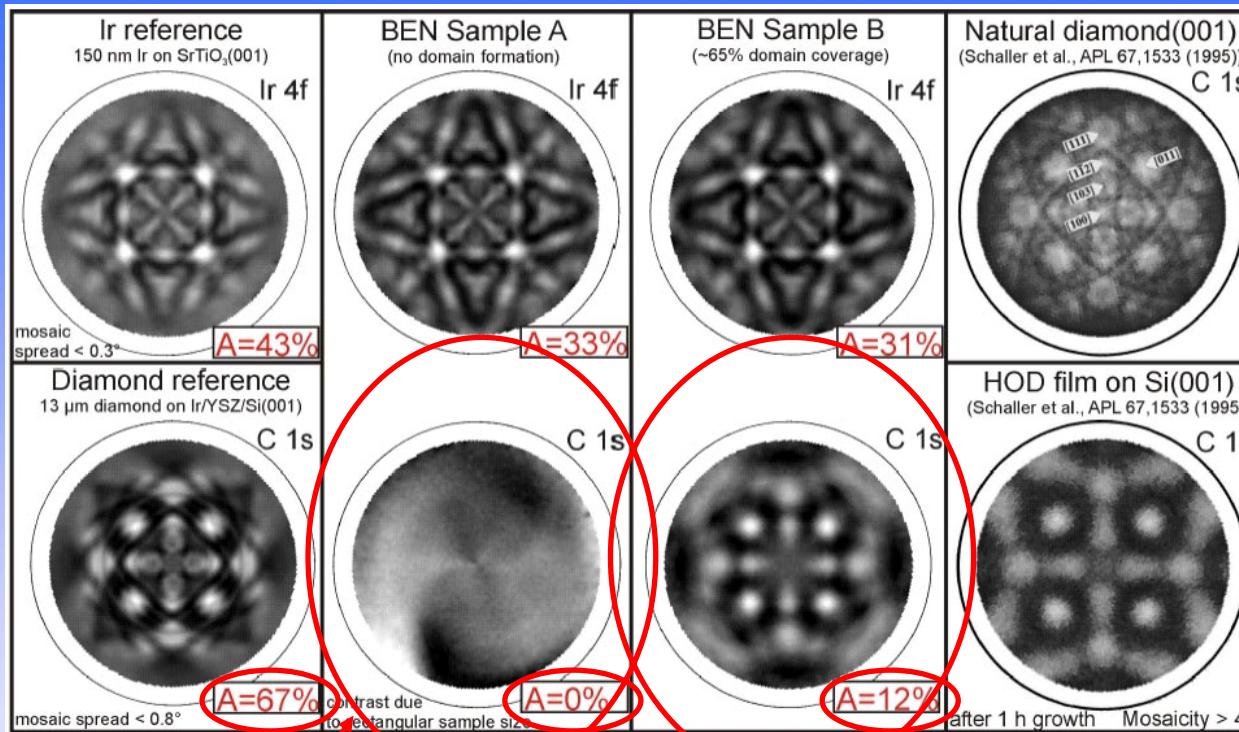


HIGH RESOLUTION IMAGES OF THE INTERFACE REGION (FLAT & ROUGH SAMPLE)



- Epitaxial iridium covering layer (preferentially on rough sample)
 - Amorphous regions?!
 - Atomically resolved structures show **only** iridium's lattice constant
- In addition: No diamond related spots in LEED or RHEED

X-RAY PHOTOELECTRON DIFFRACTION (XPD)



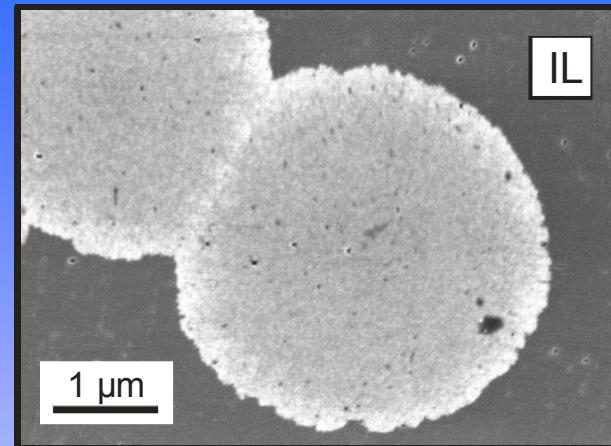
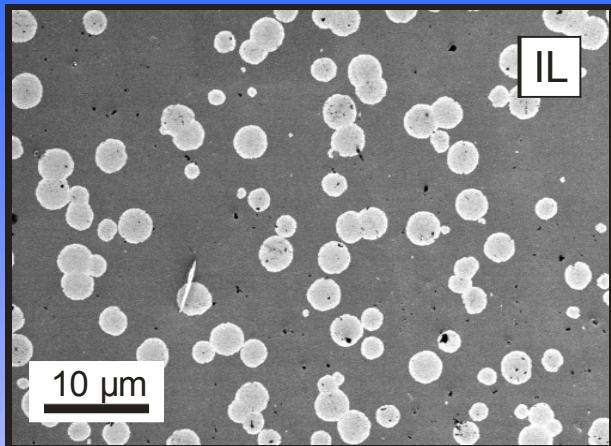
- no XPD C1s pattern in case of unsuccessful nucleation
- XPD C1s pattern similar to highly oriented polycrystalline diamond in case of successful BEN
- anisotropy values → compatible with diamond grains of 10 nm lateral size !!??

The topographic signature of the domains?

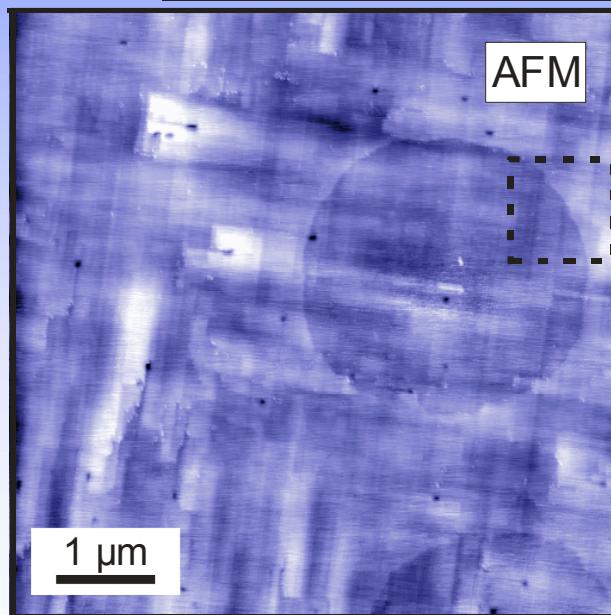


TOPOGRAPHIC SIGNATURE OF THE DOMAINS

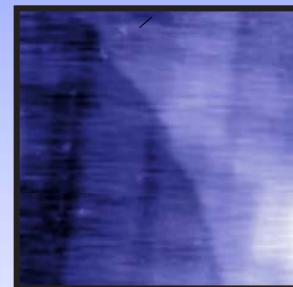
SEM



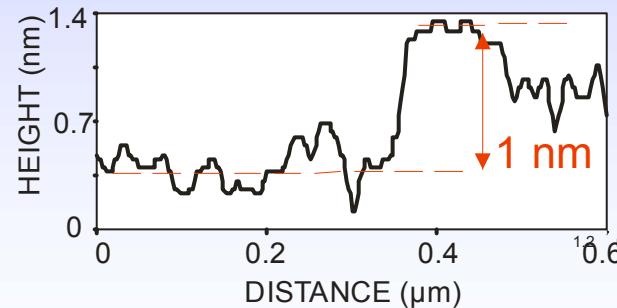
Nucleation in
a pure DC
discharge



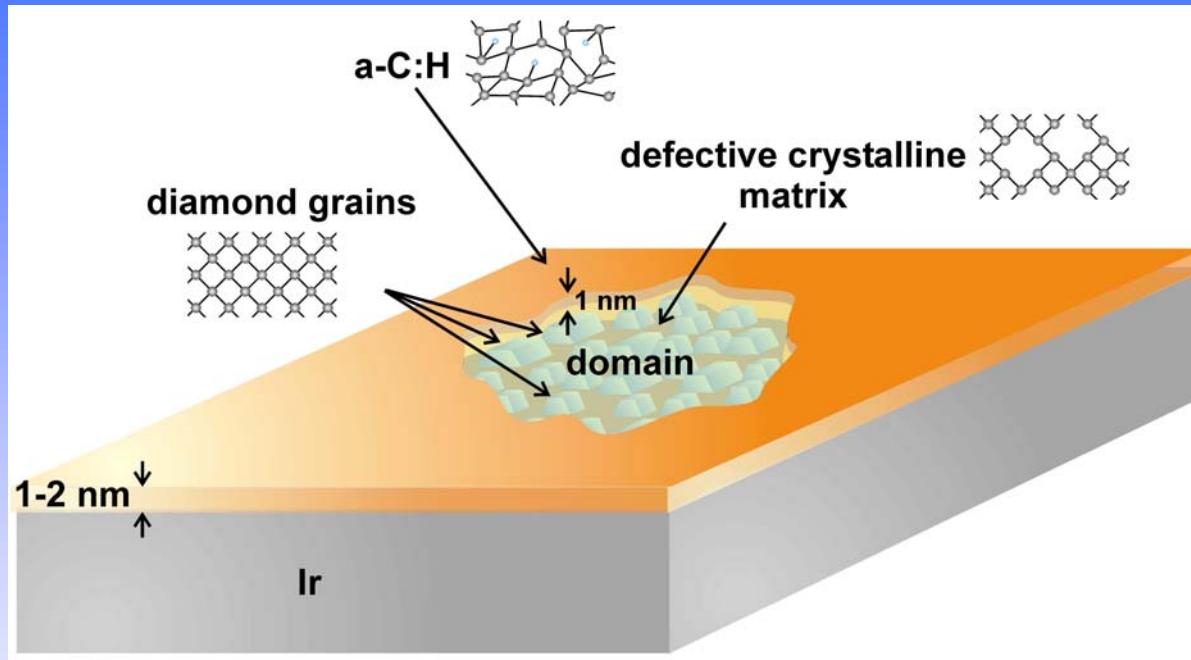
6.8 nm
0 nm



MEAN STEP HEIGHT:
 $1.1 \pm 0.1 \text{ nm}$



A MODEL DESCRIBING THE STRUCTURE OF THE BEN LAYER INCLUDING THE DOMAIN



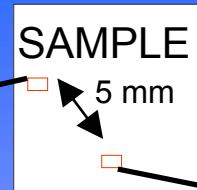
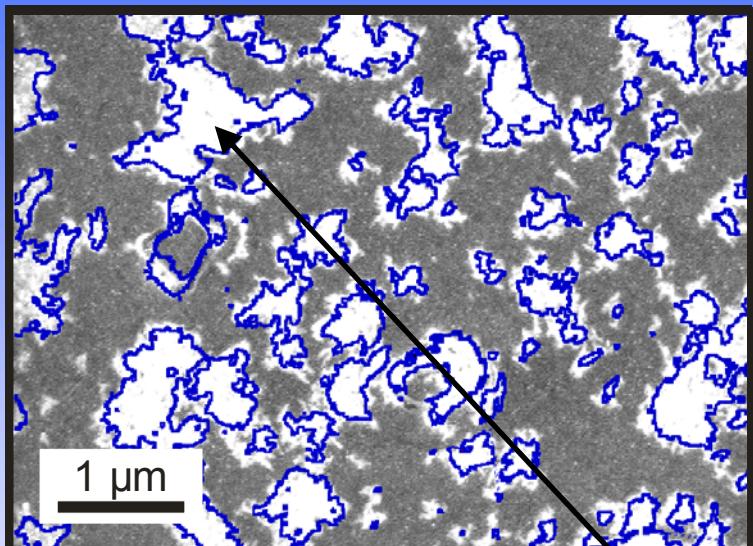
- The layer formed during BEN consists of **3 different carbon phases**
- Significantly lower density of the amorphous precursor phase

The temporal dynamics of pattern formation?



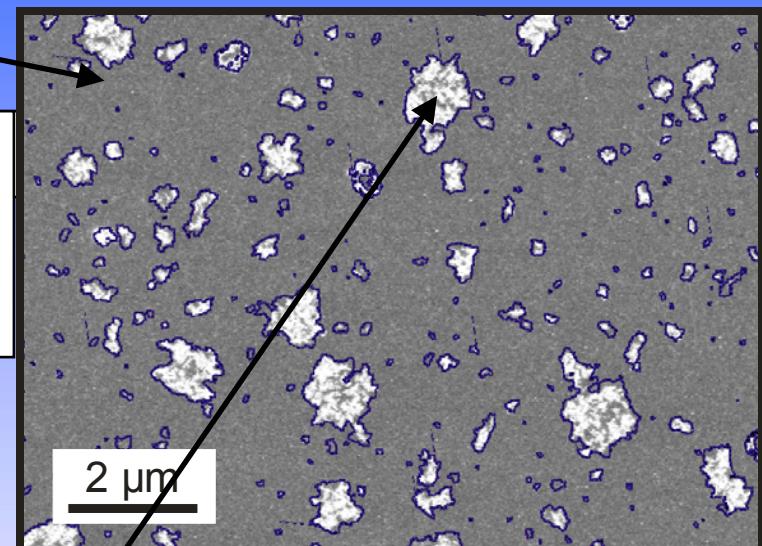
TEMPORAL DYNAMICS OF PATTERN FORMATION

POSITION 1



60 min BEN
+
15 min BEN

POSITION 2



LATERAL GROWTH
AND NUCLEATION

EROSION AND
DISSOLUTION

How did they start to grow ?

→ domain formation (or dissolution) is a continuous process



SUMMARY

Heteroepitaxial diamond growth: a promising concept for the realization of large area single crystal diamond layers

Bias enhanced nucleation a powerful nucleation method

Iridium, a unique material for the nucleation of diamond
 SrTiO_3 and YSZ: two alternative buffer layers to grow diamond/diamond/Ir films on silicon

New experiments on the pattern formation (“domains”) during BEN on Ir

A model was presented which can consistently explain a large variety of experimental observations

Thanks for your attention!



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